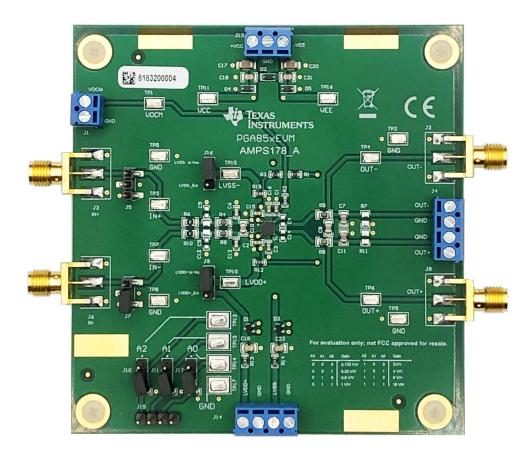


ABSTRACT



This user's guide contains information and support documentation for the PGA855 evaluation module (EVM). Included are the circuit description, jumper settings, required connections, printed circuit board (PCB) layout, schematic, and bill of materials of the PGA855EVM. Throughout this document, the terms evaluation board, evaluation module, and EVM are synonymous with the PGA855EVM.

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Trademarks

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www.ti.com Overview

1 Overview

The PGA855 is a precision, high-bandwidth programmable gain instrumentation amplifier with fully differential outputs optimized to drive high-performance analog-to-digital converters (ADCs) and fully differential inputs. The PGA855 is equipped with eight binary gain settings, from an attenuating gain of 0.125 V/V to a maximum of 16 V/V, using three digital gain-selection pins. The output common-mode voltage can be independently set using the VOCM pin. The device features super-beta input transistors from Texas Instruments, which provide ultra-low input offset voltage, offset drift, input bias current, input voltage noise, and current noise. For a full list of the electrical characteristics for the PGA855, see the PGA855 Low-Noise, High-Bandwidth, Fully Differential Output Programmable-Gain Instrumentation Amplifier data sheet.

1.1 Related Documentation

The following document provides information regarding Texas Instruments integrated circuits used in the assembly of the PGA855EVM. This user's guide is available from the TI website under literature number SBOU296. Any letter appended to the literature number corresponds to the document revision that is current at the time of the writing of this document. Newer revisions are available from the TI website at https://www.ti.com/, or call the Texas Instruments Literature Response Center at (800) 477-8924 or the Product Information Center at (972) 644-5580. When ordering, identify the document by both title and literature number.

Table 1-1. Related Documentation

Device	Literature Number	
PGA855	SBOSAE0	

1.2 Electrostatic Discharge Caution

CAUTION

Many of the components on the PGA855EVM are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

1.3 Hot Surface Warning

WARNING

Device can become hot under high-current conditions. Take care when handling the EVM.

EVM Circuit Description www.ti.com

2 EVM Circuit Description

This EVM provides access to the features and measures the performance of the PGA855 device. The PGA855 is equipped with eight binary gain settings, from an attenuating gain of 0.125 V/V to a maximum of 16 V/V, using three digital gain selection pins. By default, the PGA855EVM programmable gain amplifier is configured to a gain of 0.125 V/V. The evaluation board provides shunt jumpers J10, J11, and J12 to set the PGA855 gain.

The device uses two sets of voltage supplies: input stage and output stage. The output-stage power supplies are decoupled from the input stage to limit the PGA855 output-swing voltage level protecting the ADC or downstream device against overdrive damage. The input-stage supplies, VS+ and VS-, are accessible using connector J13. The output-stage supplies, LVDD+ and LVSS-, are accessible using connector J14. Selectable jumpers J9 and J16 set the output-stage supply voltage level equal to the input-stage supplies (default), or to external voltages using connector J14.

The PGA855 incorporates features that simplify interfacing to a fully differential ADC. The output common-mode voltage can be independently set by using the VOCM pin. The VOCM connector sets the output common-mode voltage. If the VOCM connector is not driven, the output common-mode voltage defaults to the PGA855 output stage mid-supply value. The PGA855EVM allows access to the FDA_IN- and FDA_IN+ pins with optional capacitors C4 and C14. These capacitors are in parallel with the PGA855 output-stage internal-feedback resistors to implement noise filtering. Figure 2-1 displays a simplified block diagram of the PGA855EVM. Revision A of the PGA855EVM connects the VOCM voltage divider resistors R1 and R3 to the LVDD+ and LVSS- output-stage supplies. For a full schematic of the PGA855EVM and revision details, see Figure 8-1.

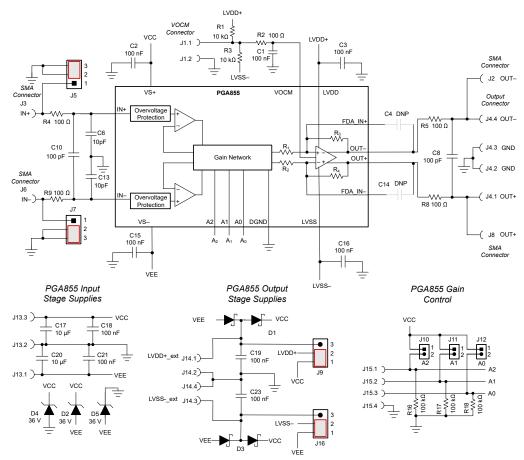


Figure 2-1. PGA855EVM Simplified Schematic

www.ti.com Jumper Settings

3 Jumper Settings

Figure 3-1 details the default jumper settings of the PGA855EVM. Table 3-1 explains the configuration for these jumpers.

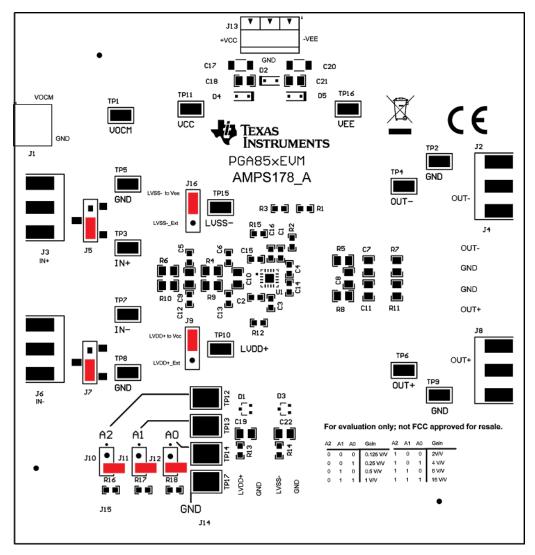


Figure 3-1. PGA855EVM Default Jumper Settings

Table 3-1. Default Jumper Configuration

Jumper	Function	Default Position	Description
J5	Positive (noninverting) input, IN+	Shunt 2-3	Shunt 2-3: Input signal to SMA connector J3 Shunt 1-2 connects IN+ to GND
J7	Negative (inverting) input, IN-	Shunt 2-3	Shunt 2-3: Input signal to SMA connector J6 Shunt 1-2 connects IN– to GND
J9	LVDD+ connection	Shunt 1-2	Shunt 1-2: Sets output stage supply LVDD+ to +VCC supply Shunt 2-3 connects LVDD+ to external connector J14 pin 1
J16	LVSS- connection	Shunt 1-2	Shunt 1-2: Sets output stage supply LVDD- to –VEE supply Shunt 2-3 connects LVDD– to external connector J14 pin 3
J10	PGA gain CTRL A2	Open	Open: Sets A2 to GND or 0 Shunt 1-2: Sets A2 to VCC or 1
J11	PGA gain CTRL A1	Open	Open: Sets A1 to GND or 0 Shunt 1-2: Sets A1 to VCC or 1
J12	PGA gain CTRL A0	Open	Open: Sets A0 to GND or 0 Shunt 1-2: Sets A0 to VCC or 1

4 Power-Supply Connections

The PGA855EVM uses two sets of voltage supplies: input stage and output stage. The device operates using input-stage power supplies from ±4 V (8 V) to ±18 V (36 V) and output-stage power supplies from ±2.25 V (4.5 V) to ±18 V (36 V). The output-stage supply voltage must not exceed the input-stage supply voltage.

The input-stage power-supply connections for the PGA855EVM are provided through connector J13 at the top of the EVM. The input-stage positive power-supply connection is labeled +VCC, the negative power-supply connection is labeled –VEE, and the ground connection is labeled GND. To connect power to the PGA855EVM, insert wires into each terminal of J13 and then tighten the screws to make the connection. Table 4-1 summarizes the pin definition for supply connector J1 and the allowed voltage range for each supply connection.

Table 4-1. PGA855EVM Supply-Range Specifications

Connector Pin Number	Supply Connection Voltage Range	
J13.3	Input-stage positive supply (+VCC)	Single supply, $V_S = +VCC$: 8 V to 36 V Dual supply, $V_S = (+VCC) - (-VEE)$: 4 V to 18 V
J13.2	Ground	0 V
J13.1	Negative supply (–VEE)	Single supply, $V_S = +VCC$: 0 V (GND) Dual supply, $V_S = (+VCC) - (-VEE)$: -4 V to -18 V
J14.1	LVDD+_ext	Single supply, LVDD+_ext: 4.5 V to 36 V Dual supply, output stage supply (LVSS+) – (LVSS–): 2.25 V to 18 V
J14.2	Ground	0 V
J14.3	LVSSext	Single supply, LVSSext: 0 V (GND) Dual supply, output stage supply (LVSS+) - (LVSS-): -2.25 V to -18 V
J14.4	Ground	0 V

By default, the output-stage supply-voltage levels (+LVDD and –LVSS) are set to the PGA855 positive (+VCC) and negative (–VEE) supplies, respectively. The +LVDD pin is connected to +VCC through jumper J9 1-2, and the –LVSS pin is connected to –VEE through J16 1-2. Screw terminal connector J14 provides access to the output-stage supply pins. To set the voltage level of LVDD and LVSS with an external supply, shunt jumper J9 2-3 to access the +LVDD using connector J14.1. In a similar fashion, shunt jumper J16 2-3 to access the –LVSS pin using connector J14.3.

Figure 4-1 shows the PGA855EVM voltage supply connections.



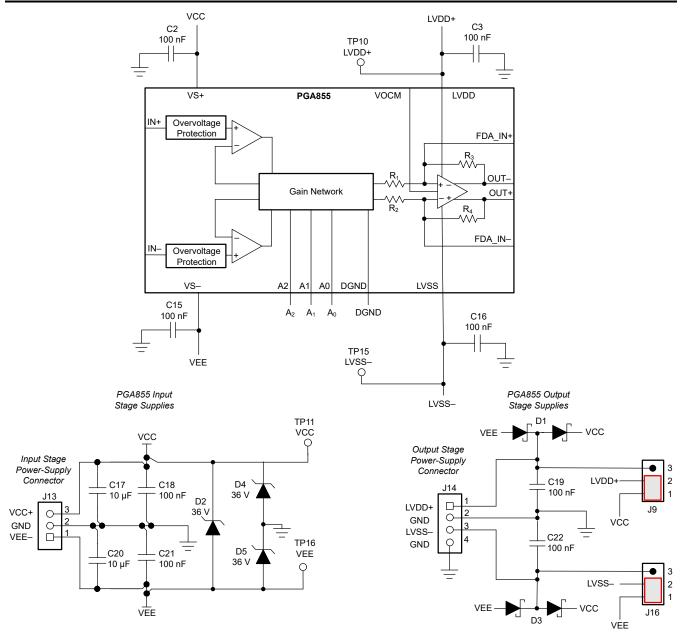


Figure 4-1. PGA855EVM Voltage Supply Connections



5 Analog Input and Output Connections

The programmable amplifier input signal connections for the PGA855EVM are provided through the use of SMA connectors J3, J6, and test points TP3, TP7, located at the left of the EVM. The VOCM input is provided through screw-terminal connector J1, located on the left of the board.

The differential output amplifier connections are provided through screw-terminal connector J4, SMA connectors J2 and J8, and test points TP4 and TP6, located at the right side of the EVM. Figure 5-1 displays a simplified diagram of the PGA855EVM input and output connections.

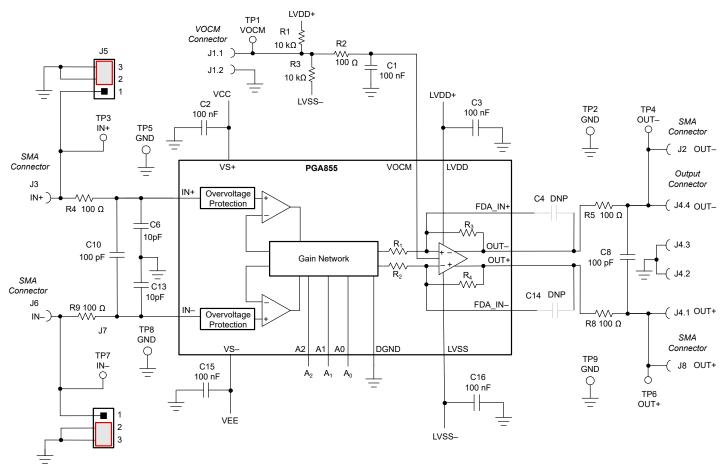


Figure 5-1. PGA855EVM Analog Input and Output Connections

Table 5-1 summarizes the input and output connectors and corresponding test points.

Table 5-1. PGA855EVM Analog Input and Output Connections				
Connector Designator	Signal	Comment	Test Point	
J3	IN+	SMA	TP3	
J6	IN-	SMA	TP7	
J2	OUT-	SMA	TP4	
J8	OUT+	SMA	TP6	
J4.4	OUT-	Screw terminal	TP4	
J4.3	GND	Screw terminal	TP2	
J4.2	GND	Screw terminal	TP9	
J4.1	OUT+	Screw terminal	TP6	
J1.1	VOCM	Screw terminal	TP1	
J1.2	GND	Screw terminal	N/A	



6 Digital Input Pins and Gain Control

The PGA855 provides eight binary gain settings, from an attenuating gain of 0.125 V/V to a maximum of 16 V/V. The gain is controlled by three digital selection pins: A0, A1, and A2. By default, the PGA855 is configured to a gain of 0.125 V/V.

The evaluation board provides shunt jumpers J10, J11, and J12 to set the PGA855 gain-control selection pins. Table 6-1 lists the gain-control options. To set the gain-control pin high, install the shunt on the corresponding jumper. To set the gain-control pin low, remove the shunt jumper.

Table 6-1. I GA033EVIII Galli Collition					
A2 Jumper J10 Connector J15.1	A1 Jumper J11 Connector J15.2	A0 Jumper J12 Connector J15.3	PGA Gain (V/V)		
Low (Open)	Low (Open)	Low (Open)	0.125		
Low (Open)	Low (Open)	High (Shunt)	0.25		
Low (Open)	High (Shunt)	Low (Open)	0.5		
Low (Open)	High (Shunt)	High (Shunt)	1		
High (Shunt)	Low (Open)	Low (Open)	2		
High (Shunt)	Low (Open)	High (Shunt)	4		
High (Shunt)	High (Shunt)	Low (Open)	8		
High (Shunt)	High (Shunt)	High (Shunt)	16		

Table 6-1. PGA855EVM Gain Control

Alternatively, the A0, A1, and A2 digital pins can be driven externally through connector J15. Any pin that is not driven by an external source, or any shunt that is left open, is biased at DGND using pulldown resistors. Figure 6-1 shows the gain-setting block diagram.

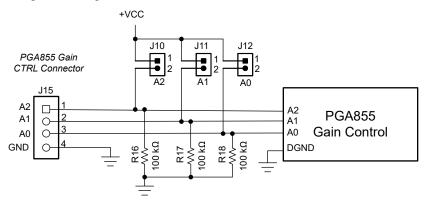


Figure 6-1. PGA855EVM Gain Control

NSTRUMENTS Modifications www.ti.com

7 Modifications

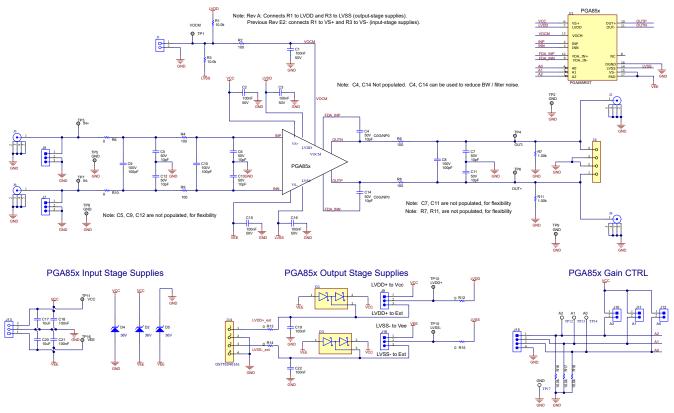
For flexibility, the EVM provides optional capacitors C4 and C18. These capacitors are in parallel with the PGA855 output-stage internal-feedback resistors to implement noise filtering. In addition, the evaluation board provides footprints R6, R10, C9, C5, and C12 for optional input low-pass filters, and footprints for load resistors R7 and R11. These additional component footprints in the layout allow the user to customize the evaluation circuit. For a full schematic of the PGA855EVM, see Figure 8-1.

8 Schematic, PCB Layout, and Bill of Materials

This section contains the schematic, PCB layout, and bill of materials for the PGA855EVM.

8.1 Schematic

Figure 8-1 illustrates the EVM schematic.



Note: DNP components are not populated.

Figure 8-1. PGA855EVM Schematic

8.2 PCB Layout

The PGA855EVM is a four-layer PCB design. Figure 8-2 to Figure 8-6 show the PCB layer illustrations. The top layer consists of all signal path traces, and is poured with a solid ground plane. A symmetrical board layout is used at the differential inputs and outputs to keep good performance matching and improve common-mode noise rejection. Route traces as symmetrically as possible for both positive and negative pathways. The optional differential input low-pass filter capacitor is placed in very close proximity to the PGA inputs to reduce extrinsic noise. Capacitor C1 is placed in close proximity to VOCM to avoid injecting common-mode noise. Decoupling capacitors C2, C15, C3 and C16 are positioned on the top layer as close as possible to the power-supply pins of the device. The second internal layer is a dedicated solid GND plane. Independent vias are placed at the ground connection of every component to provide a low-impedance path to ground. The third internal layer and bottom layer route the input stage power supplies and the output-stage supply connections.

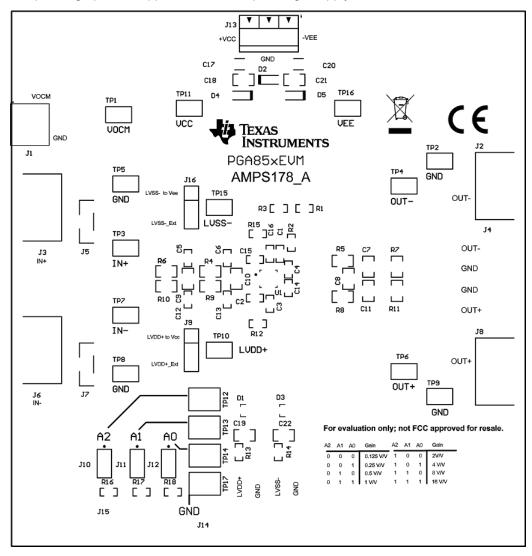


Figure 8-2. Top Overlay PCB Layout



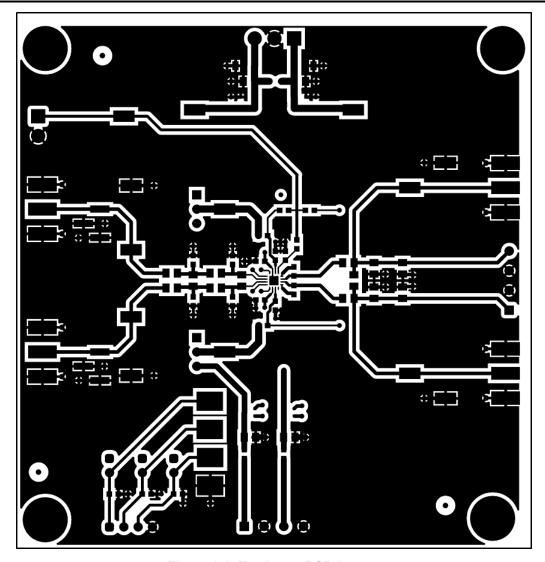


Figure 8-3. Top Layer PCB Layout



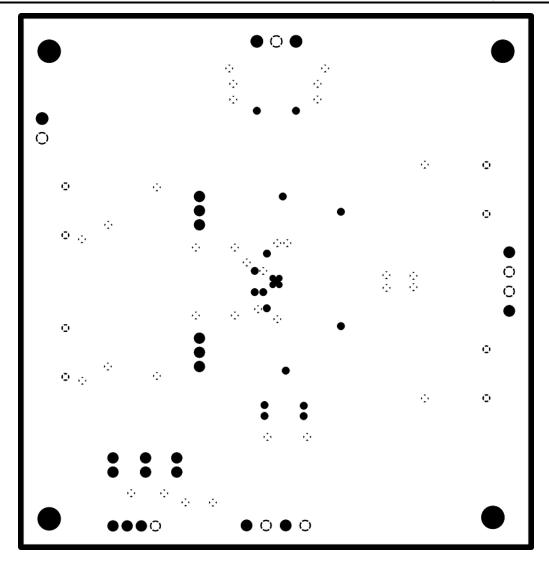


Figure 8-4. Ground Layer PCB Layout

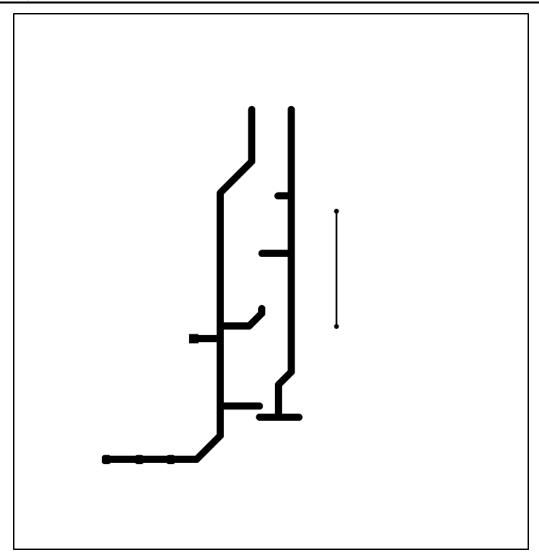


Figure 8-5. Power Layer PCB Layout



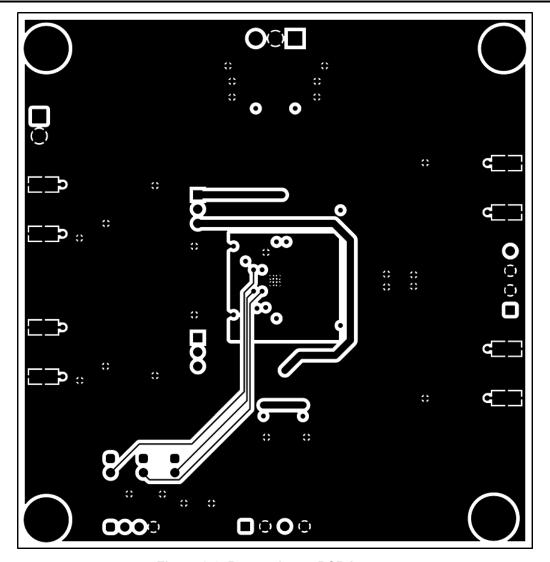


Figure 8-6. Bottom Layer PCB Layout



8.3 Bill of Materials

Table 8-1 lists the PGA855EVM bill of materials (BOM).

Table 8-1. PGA855EVM Bill of Materials

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer
!PCB1	1		Printed Circuit Board		AMPS178	Any
C1, C2, C3, C15, C16	5	0.1 μF	CAP, CERM, 0.1 uF, 50 V, +/- 5%, X7R, 0603	603	C0603C104J5RACTU	Kemet
C6, C13	2	10 pF	CAP, CERM, 10 pF, 50 V, +/- 1%, C0G/NP0, 0603	603	C0603C100F5GAC7867	Kemet
C7, C11	2	10 pF	CAP, CERM, 10 pF, 50 V, +/- 5%, C0G/NP0, 0805	805	08055A100JAT2A	AVX
C8, C10	2	100 pF	CAP, CERM, 100 pF, 100 V, +/- 5%, C0G/NP0, 0805	805	C0805C101J1GACTU	Kemet
C17, C20	2	10 μF	CAP, CERM, 10 uF, 35 V, +/- 10%, X7R, 1206	1206	C3216X7R1V106K160AC	TDK
C18, C19, C21, C22	4	0.1 µF	CAP, CERM, 0.1 uF, 50 V, +/- 10%, X7R, 0805	805	08055C104KAT2A	AVX
D1, D3	2		Diode Array 1 Pair Series Connection Schottky 40 V 200 mA (DC) Surface Mount SC-70, SOT-323	SOT-323	BAT854SWF	Nexperia
D2, D4, D5	3	36 V	Diode, TVS, Uni, 36 V, 75 Vc, SOD-323	SOD-323	CDSOD323-T36S	Bourns
H1, H2, H3, H4	4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Screw	NY PMS 440 0025 PH	B&F Fastener Supply
H5, H6, H7, H8	4		Standoff, Hex, 0.5"L #4-40 Nylon	Standoff	1902C	Keystone
J1	1		Terminal Block, 3.5mm Pitch, 2x1, TH	7.0x8.2x6.5mm	ED555/2DS	On-Shore Technology
J2, J3, J6, J8	4		Connector, End launch SMA, 50 ohm, SMT	End Launch SMA	142-0701-801	Cinch Connectivity
J4, J14	2		TERM BLOCK 3.5MM VERT 4POS PCB	HDR4	OSTTE040161	On Shore Technology
J5, J7	2		Header, 100mil, 3x1, Gold, SMT	Samtec_TSM-103-01-X-SV	TSM-103-01-L-SV	Samtec
J9, J16	2		Header, 100mil, 3x1, Gold, TH	PBC03SAAN	PBC03SAAN	Sullins Connector Solutions
J10, J11, J12	3		Header, 100mil, 2x1, Gold, TH	2x1 Header	TSW-102-07-G-S	Samtec
J13	1		Terminal Block, 3.5mm Pitch, 3x1, TH	10.5x8.2x6.5mm	ED555/3DS	On-Shore Technology
J15	1		Header, 100mil, 4x1, Gold, TH	4x1 Header	TSW-104-07-G-S	Samtec
R1, R3	2	10 kΩ	RES, 10.0 k, 1%, 0.1 W, 0603	603	ERJ-3EKF1002V	Panasonic
R2	1	100 Ω	RES, 100, 1%, 0.1 W, 0603	603	RC0603FR-07100RL	Yageo
R4, R5, R8, R9	4	100 Ω	RES, 0, 0.1%, 0.125 W, 0805	805	RT0805BRD07100RL	Yageo America
R6, R10	2	0 Ω	RES, 0, 5%, 0.125 W, AEC-Q200 Grade 0, 0805	805	ERJ-6GEY0R00V	Panasonic
R12, R13, R14, R15	4	0 Ω	RES, 0, 5%, 0.1 W, 0603	603	RC0603JR-070RL	Yageo
R16, R17, R18	3	10.0 kΩ	RES, 10.0 k, 1%, 0.1 W, 0603	603	RCG060310K0FKEA	Vishay Draloric



Table 8-1. PGA855EVM Bill of Materials (continued)

Table 6-1. 1 GA000EVIII Bill of Materials (Continued)						
Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer
SH-J1, SH-J2, SH- J3,SH-J4 ,SH-J5,SH-J6	6	1 × 2	Shunt, 100mil, Flash Gold, Black	Closed Top 100mil Shunt	SPC02SYAN	Sullins Connector Solutions
TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8, TP9, TP10, TP11, TP15, TP16	13		Test Point, Miniature, SMT	Test Point, Miniature, SMT	5019	Keystone
TP12, TP13, TP14, TP17	4		Test Point, Compact, SMT	Testpoint_Keystone_Comp act	5016	Keystone
U1	1		Low-Noise, Wide-Bandwidth, Fully Differential Output, Programmable Gain Amplifier	VQFN17	PGA855RGT	Texas Instruments

INSTRUMENTS Revision History www.ti.com

9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

С	hanges from Revision * (April 2023) to Revision A (September 2023)	Page
•	Changed board image	1
	Changed PGA855EVM Simplified Schematic to show updated VOCM voltage divider connections	
•	Added information regarding PCB revision	<mark>4</mark>
•	Changed PGA855EVM Default Jumper Settings image to show updated RTM silkscreen	<mark>5</mark>
•	Changed PGA855EVM Analog Input and Output Connections image to show PCB changes	8
•	Changed PGA855EVM Schematic to show PCB revision	10
•	Changed Figure 8-2 through Figure 8-6	11

STANDARD TERMS FOR EVALUATION MODULES

- Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or
 documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance
 with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
 - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 Limited Warranty and Related Remedies/Disclaimers:
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after the defect has been detected.
 - 2.3 Tl's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. Tl's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by Tl and that are determined by Tl not to conform to such warranty. If Tl elects to repair or replace such EVM, Tl shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGREDATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types lated in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
 - https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above. User will be subject to penalties of Radio Law of Japan.

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- 1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用 いただく。
- 2. 実験局の免許を取得後ご使用いただく。
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- 3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html
- 3.4 European Union
 - 3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

- 4 EVM Use Restrictions and Warnings:
 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 Safety-Related Warnings and Restrictions:
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
- 5. Accuracy of Information: To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. Disclaimers:

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 - 8.2 Specific Limitations. IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY USE OF AN EVM PROVIDED HEREUNDER, INCLUDING FROM ANY WARRANTY, INDEMITY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS, , EXCEED THE TOTAL AMOUNT PAID TO TI BY USER FOR THE PARTICULAR EVM(S) AT ISSUE DURING THE PRIOR TWELVE (12) MONTHS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM SHALL NOT ENLARGE OR EXTEND THIS LIMIT.
- 9. Return Policy. Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.
- 10. Governing Law: These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.

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